

C-Band, GaN/SiC, RF Power Transistor

5.2 - 5.9 GHz | 75 W | 50% Efficiency | 13 dB Gain | 28 V

IGT5259CW50 and IGT5259CW50S are high power GaN-on-SiC RF power transistors that have been designed to suit the unique needs of C-Band Radar Systems. They operate over the full bandwidth of 5.2-5.9 GHz. Under CW conditions, they supply 50 W of RF output power, with an associated 11 dB of gain and 40% efficiency. They operate from a 28 V supply voltage. For optimal thermal efficiency, the transistors are housed in a metal-based package with an epoxysealed ceramic lid.



FEATURES

- GaN on SiC HEMT Technology
- Output Power >50 W
- Fully matched to 50 Ω Impedance at both Input and Output
- High Efficiency up to 50%
- 100% RF Tested
- RoHS and REACH Compliant
- IGT5259CW50 has a bolt-down flange, IGT5259CW50S is the earless flange option



APPLICATIONS

C-band Radar Systems

Table 1. RF Electrical Characteristics (Case temperature = 30 °C unless otherwise stated)

| Parameter | Symbol | Min | Тур | Max | Units | Test Conditions |
|-------------------------|----------|------|------|------|-------|--------------------------------|
| Input Return Loss | IRL | 6 | 10 | 18 | dB | P _{OUT} = 50W |
| Gain | G | 7.45 | 11.6 | 14.0 | dB | f = 5.2, 5.55, 5.9GHz |
| Drain Efficiency | η | 38 | 45 | 75 | % | |
| Load Mismatch Stability | VSWR-S | 2:1 | | | | CW |
| VSWR Withstand | VSWR-LMT | 3:1 | | | | $V_{DS} = 28V, I_{DS} = 20mA,$ |



Table 2. Absolute Maximum Ratings (Not Simultaneous)

| Parameter | Symbol | Value | Units | Test Conditions |
|--------------------------------|---------------------|-------------|-------|-----------------|
| DC Drain-Source Voltage | V _{DS} | 130 | V | 25 °C |
| DC Gate-Source Voltage | V _{GS} | -8 to +1.0 | V | 25 °C |
| DC Drain Current | I _D | 9.6 | A | 25 °C |
| DC Gate Current | I _G | 1 | mA | 25 °C |
| RF Input Power | P _{REIN} | 8 | W | 25 °C |
| Operating Junction Temperature | T _J | -55 to +200 | °C | |
| Storage Temperature | T _{STG} | -55 to +150 | °C | |
| Soldering Temperature | T _{SOLDER} | 260 for 10s | °C | |

Note: Operation outside the limits given in this table may cause permanent damage to the transistor

Table 3. DC Electrical Characteristics (Case temperature = 25 °C unless otherwise stated)

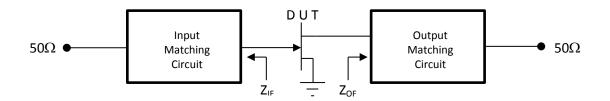
| Parameter | Symbol | Min | Тур | Max | Units | Test Conditions |
|------------------------|----------------|------|------|-----|-------|---------------------------------|
| Gate Pinch-Off Voltage | V _P | -5.0 | | | V | $V_{DS} = 50V$, $I_{DS} = 1mA$ |
| Quiescent Gate Voltage | V _Q | | -2.6 | | V | $V_{DS} = 50V$, $I_{DS} = 1mA$ |

Table 4. Thermal Resistance (Case temperature = 85 °C unless otherwise stated)

| Parameter | Symbol | Min | Тур | Max | Units | Test Conditions |
|---|-----------------|-----|-----|-----|-------|--|
| Peak Thermal Resistance, Channel to Case | R _{TH} | 0.8 | 0.9 | 1.0 | °C/W | $P_{OUT} = 61.1W$ CW $V_{DS} = 28V, I_{DS} = 20mA$ |

Table 5. Test Fixture Source & Load Impedances (Case temperature = 25 °C unless otherwise stated)

| Frequency (GHz) | Z _{IF} | Z _{of} | Units | Test Conditions |
|-----------------|-----------------|-----------------|-------|------------------------------------|
| 5.2 | 50 + j0 | 50 + j0 | Ω | P _{out} = 50W |
| 5.55 | 50 + j0 | 50 + j0 | Ω | CW $V_{DS} = 28V, I_{DS} = 20mA$ |
| 5.9 | 50 + j0 | 50 + j0 | Ω | |

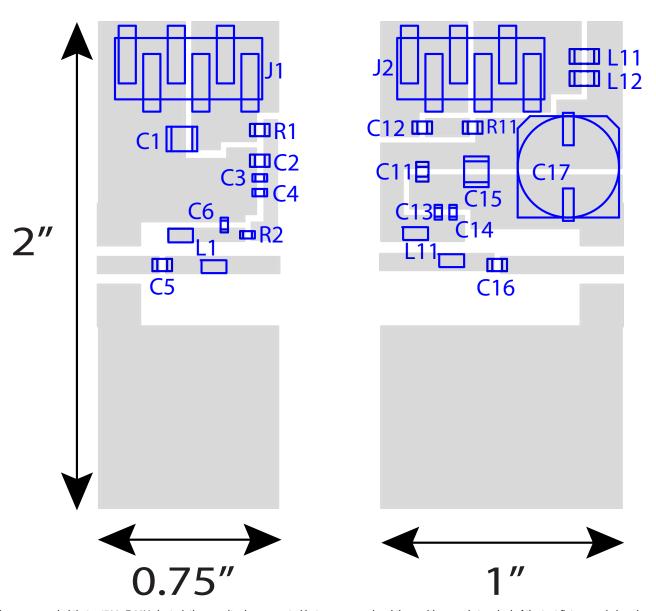


DC Bias Sequencing

| TURN ON SEQUENCE | TURN OFF SEQUENCE |
|---|--|
| Turn RF Power OFF Set V_{as} = -5V (Negative Voltage to pinch off FET) Measure I_{DS} current, should be <1mA. Turn ON V_{DS} voltage. Slowly increase V_{as} until bias current reaches I_{DQ}. Turn ON RF Power | Turn OFF RF Power Turn OFF V_{DS} voltage After V_{DS} is discharged, set V_{GS} = -5V Turn OFF V_{GS} voltage. |



TEST FIXTURE



Note: it is recommended that a $4700\mu F$ 63V electrolytic capacitor be connected between ground and the positive supply terminal of the test fixture, and placed as close as possible to the test fixture, in order to minimise pulse droop.

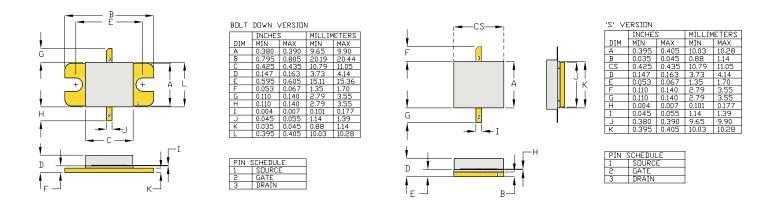


Bill of Materials for IGT5259CW50 Test Fixture

| Designator | Description | Part Number |
|--------------|---|-------------------|
| C1 | CAP 4.7μF, 1210, 25V | C1210C475K3RACTU |
| C2, C11, C12 | CAP 0.1μF, 0805, 100V | C2012X7R2A104K125 |
| C3,C14 | CAP 10PF, 250V, 0603 | 600S100FT250XT |
| C4, C6, C13 | CAP 3.9pF, 0603, 250V | 600S3R9BT250XT |
| C5, C16 | CAP 6.8pF, 0805, 250V | 600F6R8BT250XT |
| C15 | CAP 1μF, 1210, 100V, X7R | |
| C17 | CAP, 33μF , C10X10, Electrolytic, 100V | UCZ2A330MCL1GS |
| FB11, FB12 | IND, FB, 120 OHM, 1206, 5A | BLM31PG330SN1L |
| L1, L11 | IND, 8N0 | CC_A03TGLB |
| R1 | RES, 100 OHM, 0805 | |
| R2 | RES, 15OHM,0603 | |
| R11 | RES, 10 OHM, 0805 | CRCW080510R0JNEA |
| PC BOARD | TACONIC RF-35TC-0300-E-C1/C1, 0.030", 10z/10z Copper | |



PACKAGE PL44C2



BOLT-DOWN FLANGE OPTION IGT5259CW50

EARLESS FLANGE OPTION IGT5259CW50S

Dimensions: Inches (mm)



ESD & MSL Rating

| Parameter | Rating | Standard | |
|---------------------------------|----------------------|------------------------|--|
| ESD Human Body Model (HBM) | TBD | ESDA/JEDEC JS-001-2012 | |
| ESD Charged Device Model (CDM) | TBD | JEDEC JESD22-C101F | |
| Moisture Sensitivty Level (MSL) | Unlimited Shelf Life | IPC/JEDEC J-STD-020 | |

RoHS Compliance

Integra Technologies, Inc declares that its GaN and LDMOS Transistor Products comply with EU Directive 2011/65/EU on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863/EU.

REACH Compliance

Integra Technologies supports EU Regulation number 1907/2006 concerning the Registration, Evaluation, Authorization, and Restriction of Chemicals (REACH) as these apply to Integra semiconductor products, development tools, and shipping packaging.

In support of the REACH regulation, Integra will:

- Inform customers and recipients of Integra product if they contain any substances that are of very high concern (SVHC) per the European Chemical Agency (ECHA) website.
- •Notify ECHA if any Integra product that contains any SVHCs which exceed guidelines for REACH chemicals by weight per part number and for total content weight per year for all products produced in or imported to the European market.
- •Cease shipments of product containing REACH Annex XIV substances until authorization has been obtained.
- Cease shipment of product containing REACH Annex XVII chemicals when restrictions apply.

Integra has evaluated its materials, BOMs, and product specifications and product and has determined that this transistor conforms to all REACH and SVHC regulations and guidelines. Integra has implemented actions and control programs that will assure continued compliance.

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DATA SHEET STATUS

Advanced Specification - This data sheet contains Advanced specifications.

Preliminary Specification - This data sheet contains specifications based on preliminary measurements and data.

Final Specification - This data sheet contains final product specifications.

MAXIMUM RATINGS Stress above one or more of the maximum ratings may cause permanent damage to the device. These are maximum ratings only operation of the device at these or at any other conditions above those given in the characteristics sections of the specification is not implied. Exposure to maximum values for extended periods of time may affect device reliability.